

Halogens free devices

CHENMKO ENTERPRISE CO.,LTD

SURFACE MOUNT

P-Channel Enhancement Mode Field Effect Transistor

VOLTAGE 20 Volts CURRENT 3.5 Ampere

CHM3413SGP

APPLICATION

- * Servo motor control.
- * Power MOSFET gate drivers.
- * Other switching applications.

FEATURE

- * Small flat package. (SC-88)
- * High density cell design for extremely low R_{DSON}.
- * Rugged and reliable.
- * High saturation current capability.

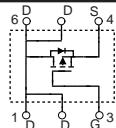
CONSTRUCTION

- * P-Channel Enhancement

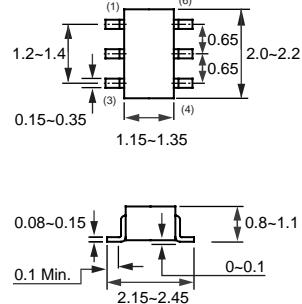
MARKING

- * 3413

CIRCUIT



SC-88/SOT-363



Dimensions in millimeters

SC-88/SOT-363

Absolute Maximum Ratings

T_A = 25°C unless otherwise noted

Symbol	Parameter	CHM3413SGP	Units
V _{DSS}	Drain-Source Voltage	-20	V
V _{GSS}	Gate-Source Voltage	±12	V
I _D	Maximum Drain Current - Continuous	-3.5	A
	- Pulsed	-15	
P _D	Maximum Power Dissipation	625	mW
T _J	Operating Temperature Range	-55 to 150	°C
T _{STG}	Storage Temperature Range	-55 to 150	°C

Thermal characteristics

R _{θJA}	Thermal Resistance, Junction-to-Ambient (Note 1)	250	°C/W
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2007-10

ELECTRICAL CHARACTERISTIC (CHM3413SGP)

Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
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OFF CHARACTERISTICS

BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-20			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}} = -20 \text{ V}, V_{\text{GS}} = 0 \text{ V}$			-1	μA
I_{GSSF}	Gate-Body Leakage	$V_{\text{GS}} = 12 \text{ V}, V_{\text{DS}} = 0 \text{ V}$			+100	nA
I_{GSSR}	Gate-Body Leakage	$V_{\text{GS}} = -12 \text{ V}, V_{\text{DS}} = 0 \text{ V}$			-100	nA

ON CHARACTERISTICS (Note 2)

$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250 \mu\text{A}$	-0.36		-0.8	V
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}} = -4.5 \text{ V}, I_D = -3.4 \text{ A}$		76	95	$\text{m}\Omega$
		$V_{\text{GS}} = -2.5 \text{ V}, I_D = -2.4 \text{ A}$		97	120	
g_{FS}	Forward Transconductance	$V_{\text{DS}} = -5 \text{ V}, I_D = -2.8 \text{ A}$		6		S

SWITCHING CHARACTERISTICS (Note 4)

Q_g	Total Gate Charge	$V_{\text{DS}} = -6 \text{ V}, I_D = -2.8 \text{ A}$ $V_{\text{GS}} = -4.5 \text{ V}$		4.8	8	nC
Q_{gs}	Gate-Source Charge			1		
Q_{gd}	Gate-Drain Charge			1		
t_{on}	Turn-On Time	$V_{\text{DD}} = -6 \text{ V}$ $I_D = -1.0 \text{ A}, V_{\text{GEN}} = -4.5 \text{ V}$ $R_G = 6 \Omega$		10	16	nS
t_r	Rise Time			13	23	
t_{off}	Turn-Off Time			18	25	
t_f	Fall Time			15	20	

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

I_s	Drain-Source Diode Forward Current				-1.5	A
V_{SD}	Drain-Source Diode Forward Voltage	$I_s = -1.5 \text{ A}, V_{\text{GS}} = 0 \text{ V}$			-1.2	V